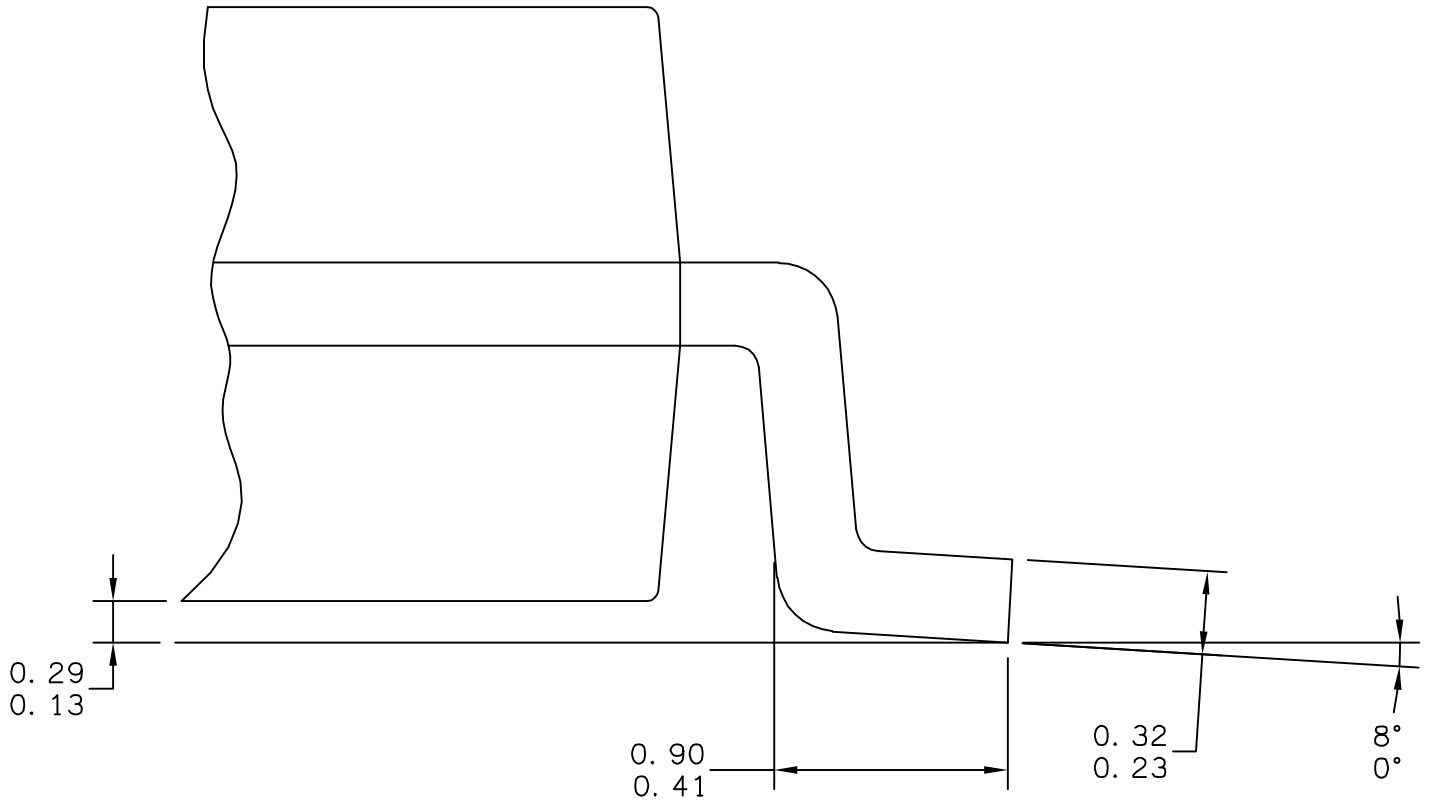


© NXP SEMICONDUCTORS N. V. ALL RIGHTS RESERVED	MECHANICAL OUTLINE	PRINT VERSION NOT TO SCALE
TITLE: SOIC, WIDE BODY, 28 LEAD CASEOUTLINE	DOCUMENT NO: 98ASB42345B	REV: J
	STANDARD: MS-013AE	
	SOT136-3	11 APR 2016



DETAIL A

© NXP SEMICONDUCTORS N. V. ALL RIGHTS RESERVED	MECHANICAL OUTLINE	PRINT VERSION NOT TO SCALE	
TITLE: SOIC, WIDE BODY, 28 LEAD CASEOUTLINE		DOCUMENT NO: 98ASB42345B	REV: J
		STANDARD: MS-013AE	
		SOT136-3	11 APR 2016



NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. THIS DIMENSION DOES NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
4. 751F-01 THRU -04 OBSOLETE. NEW STANDARD: 751F-05
5. THIS DIMENSION DOES NOT INCLUDE DAM BAR PROTRUSION ALLOWABLE DAM BAR PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF THIS DIMENSION AT MAXIMUM MATERIAL CONDITION.

© NXP SEMICONDUCTORS N. V. ALL RIGHTS RESERVED	MECHANICAL OUTLINE	PRINT VERSION NOT TO SCALE	
TITLE: SOIC, WIDE BODY, 28 LEAD CASEOUTLINE		DOCUMENT NO: 98ASB42345B	REV: J
		STANDARD: MS-013AE	
		SOT136-3	11 APR 2016